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James W. Paul
FULWIDER PATTON LEE & UTECHT, LLP
Howard Hughes Center
6060 Center Drive, 10th Floor
Los Angeles, CA 90045

EXAMINER

THANGAVELU, KANDASAMY

ART UNIT

PAPER NUMBER

2123

DATE MAILED: 04/21/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

09/592,572

Applicant(s)

DELLACONA, RICHARD

Examiner

Kandasamy Thangavelu

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-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 19 January 2005.
2a) ☒ This action is **FINAL**. 2b) ☐ This action is non-final.
3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-3,5-13,16-21,23-31 and 34-36 is/are pending in the application.
4a) Of the above claim(s) _____ is/are withdrawn from consideration.
5) ☐ Claim(s) _____ is/are allowed.
6) ☒ Claim(s) 1-3,5-13,16-21,23-31 and 34-36 is/are rejected.
7) ☐ Claim(s) _____ is/are objected to.
8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
10) ☒ The drawing(s) filed on 30 July 2004 is/are: a) ☒ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. _____.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- 1) ☒ Notice of References Cited (PTO-892)
2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948)
3) ☐ Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date _____.
4) ☐ Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____.
5) ☐ Notice of Informal Patent Application (PTO-152)
6) ☐ Other: _____.

DETAILED ACTION

Introduction

1. This communication is in response to the Applicants' Response mailed on January 19, 2005. Claims 1, 3, 5-6, 8-11, 13, 17-21, 23-26, 31 and 34-36 were amended. Claims 4, 14, 15, 22 and 32-33 were cancelled. Claims 1-3, 5-13, 16-21, 23-31 and 34-36 of the application are pending. This office action is made final.

Claim Objections

2. The following is a quotation of 37 C.F.R § 1.75 (d)(1):

The claim or claims must conform to the invention as set forth in the remainder of the specification and terms and phrases in the claims must find clear support or antecedent basis in the description so that the meaning of the terms in the claims may be ascertainable by reference to the description.

3. Claim 1 is objected to because of the following informalities:

Claim 1, Lines 16-17, "a controller providing a communication path between the CPU with each of the storage devices through its associated storage device bypass circuit board" appears to be incorrect and it appears that it should be "a controller providing a communication path between the CPU and each of the storage devices through its associated storage device bypass circuit board" appears to be correct.

Claim Rejections - 35 USC § 112

4. The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

5. Claim 1-3, 5-13, 16-21, 23-31 and 34-36 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

Claim 1, Lines 12-15 state, "and wherein the optical input/output connectors of the first and second mass storage modules are connected by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light". There is insufficient antecedent basis for "the optical input/output connectors of the first and second mass storage modules" in the claim. The optical input/output connectors are on the module bypass circuit boards of the first and second mass storage modules and not directly on the mass storage modules.

Claim 19, Lines 10-12 state, "and wherein the optical input/output connectors of the first and second mass storage modules are connected by a fiber optic transmission medium such that signals are communicated between the modules in the form of light". There is insufficient antecedent basis for "the optical input/output connectors of the first and second mass storage modules" in the claim. There is no mention of the optical input/output connectors of the first

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and second mass storage modules before this reference to the optical input/output connectors of the first and second mass storage modules.

Additionally, the optical input/output connectors are on the module bypass circuit boards of the first and second mass storage modules and not directly on the mass storage modules as indicated in item (c) latter.

Claim 23, Line 1 states, " The high speed mass storage system of claim 22 ". There is insufficient antecedent basis for this in the claim, as claim 22 does not exist anymore.

Claim Rejections - 35 USC § 103

6. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains.

7. The factual inquiries set forth in *Graham v. John Deere Co.*, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:

1. Determining the scope and contents of the prior art.
2. Ascertaining the differences between the prior art and the claims at issue.
3. Resolving the level of ordinary skill in the pertinent art.
4. Considering objective evidence present in the application indicating obviousness or nonobviousness.

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8. Claims 1-3, 5, 7 and 10-13 are rejected under 35 U.S.C. 103(a) as being unpatentable over **Leshem** (U.S. Patent 5,729,763) in view of **Espy** (International Application WO 98/21660), and further in view of **Hillis** (U.S. Patent 5,978,570), **Dekoning et al.** (U.S. Patent 6,055,228) and **Swanson et al.** (U.S. Patent 6,580,531).

8.1 **Leshem** teaches Data storage system. Specifically, as per Claim 1, **Leshem** teaches a high speed mass storage system (CL1, L4-8; CL1, L33-37; Abstract, L11-14); comprising at least one module containing:

at least one CPU (Fig 1, Item 22; CL3, L26-27).

Leshem does not expressly teach a high speed mass storage system which is readily expandable to increase its storage capacity while the system is in operation; and first and second mass storage modules. **Espy** teaches a high speed mass storage system which is readily expandable to increase its storage capacity while the system is in operation (Page 1, L19-24); and first and second mass storage modules (Fig. 1, Items 10 and 110; Page 1, L19-24), as that will enable to add an additional disk array chassis to the existing system when additional memory space is required, without shutting down the existing system (Page 1, L19-24). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included high speed mass storage system which would be readily expandable to increase its storage capacity while the system was in operation; and first and second mass storage modules. The artisan would have been motivated because that

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would enable to add an additional disk array chassis to the existing system when additional memory space was required, without shutting down the existing system.

Leshem does not expressly teach each mass storage module including a plurality of plug-in storage devices for storing information. **Espy** teaches each mass storage module including a plurality of plug-in storage devices for storing information (Fig. 1, Items 12 of Items 10 and 110; Page 5, L16-17), because as per **Hillis** the storage capacity of the mass storage module will be increased proportional to the number of plug-in storage devices for storing information (CL11, L29-33). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module including a plurality of plug-in storage devices for storing information. The artisan would have been motivated because the storage capacity of the mass storage module would be increased proportional to the number of plug-in storage devices for storing information.

Leshem does not expressly teach each mass storage module including a storage device bypass circuit board associated with each storage device each storage device being plugged into a connector on the storage device bypass circuit board. **Espy** teaches each mass storage module including a storage device bypass circuit board associated with each storage device each storage device being plugged into a connector on the storage device bypass circuit board (Fig. 1, Item 26 of Items 10 and 110; Page 5, L26-27; Page 5, L30 to Page 6, L2), because as per **Dekoning et al.** that will enable connecting the storage device to the daisy-chain communication loop, when the device is enabled; and when failure or absence of a storage device is detected bypassing the storage device by connecting the daisy chain loop without the device (CL11, L52-60). It would have been

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obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module including a storage device bypass circuit board associated with each storage device each storage device being plugged into a connector on the storage device bypass circuit board. The artisan would have been motivated because that would enable connecting the storage device to the daisy-chain communication loop, when the device was enabled; and when failure or absence of a storage device was detected bypassing the storage device by connecting the daisy chain loop without the device.

Leshem does not expressly teach each mass storage module including a module bypass circuit board. **Espy** teaches each mass storage module including a module bypass circuit board (Page 2, L5-23; Fig. 1, Item 40; Page 6, L7-16), as that will enable to add an additional disk array chassis to the existing system when additional memory space is required, without shutting down the existing system (Page 1, L19-24). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module including a module bypass circuit board. The artisan would have been motivated because that would enable to add an additional disk array chassis to the existing system when additional memory space was required, without shutting down the existing system.

Leshem does not expressly teach the module bypass circuit board including an optical input/ output connector for outputting electrical signals from the module as light signals and for inputting light signals into the module as electrical signals. **Swanson et al.** teaches the module bypass circuit board including an optical input/ output connector for outputting electrical signals from the module as light signals and for inputting light

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signals into the module as electrical signals (Fig. 2; CL1, L19-42), as optical transmission provides large capacity for digital transmission in computer/communication networks (CL1, L26-29). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Swanson et al.** that included the module bypass circuit board including an optical input/ output connector for outputting electrical signals from the module as light signals and for inputting light signals into the module as electrical signals. The artisan would have been motivated because optical transmission would provide large capacity for digital transmission in computer/communication networks.

Leshem does not expressly teach that the optical input/output connectors of the first and second mass storage modules are connected by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light. **Espy** teaches that the optical input/output connectors of the first and second mass storage modules are connected by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light (Page 2, L29 to Page 3, L6; Page 6, L7-16), because as per **Leshem** the fiber optic transmission will provide high data rates (CL1, L31-35). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included the optical input/output connectors of the first and second mass storage modules being connected by a fiber optic transmission medium such that signals were communicated between the first and second mass storage modules in the form of light. The artisan would have been motivated because the fiber optic transmission would provide high data rates.

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In addition, **Hillis** teaches that the optical input/output connectors of the first and second mass storage modules are connected by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light (Fig. 5; Fig. 6; CL10, L59 to CL11, L5; CL11, L29-33; CL11, L34-51), because fiber optic communication lines have high band width and data rates of 100 megabits per second (CL11, L43-48). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Hillis** that included the optical input/output connectors of the first and second mass storage modules being connected by a fiber optic transmission medium such that signals were communicated between the first and second mass storage modules in the form of light. The artisan would have been motivated because fiber optic communication lines would have high band width and data rates of 100 megabits per second.

Leshem teaches a controller providing a communication path between the CPU with some of the storage devices through its associated storage device bypass circuit board (CL3, L33-36; CL3, L40-50). **Leshem** does not expressly teach a controller providing a communication path between the CPU with each of the storage devices through its associated storage device bypass circuit board and through the module bypass circuit board. **Espy** teaches a controller providing a communication path between the CPU with each of the storage devices through its associated storage device bypass circuit board (Fig. 1, Item 16; Items 12, 22 and 26), because as per **Dekoning et al.** that will enable connecting the storage device to the daisy-chain communication loop, when the device is enabled; and when failure or absence of a storage device is detected bypassing

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the storage device by connecting the daisy chain loop without the device (CL11, L52-60).

It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included a controller providing a communication path between the CPU with each of the storage devices through its associated storage device bypass circuit board. The artisan would have been motivated because that would enable connecting the storage device to the daisy-chain communication loop, when the device was enabled; and when failure or absence of a storage device was detected bypassing the storage device by connecting the daisy chain loop without the device.

Leshem does not expressly teach a controller providing a communication path between the CPU with each of the storage devices through its associated storage device bypass circuit board and through the module bypass circuit board. **Espy** teaches a controller providing a communication path between the CPU with each of the storage devices through its associated storage device bypass circuit board and through the module bypass circuit board (Page 2, L5-23; Fig 1, Item 40; Page 6, L7-16), as that will enable to add an additional disk array chassis to the existing system when additional memory space is required, without shutting down the existing system (Page 1, L19-24). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included a controller providing a communication path between the CPU with each of the storage devices through its associated storage device bypass circuit board and through the module bypass circuit board. The artisan would have been motivated because that would enable to add

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an additional disk array chassis to the existing system when additional memory space was required, without shutting down the existing system.

8.2 As per Claim 2, **Leshem, Espy, Hillis, Dekoning et al.** and **Swanson et al.** teach the system of claim 1. **Leshem** does not expressly teach that each storage device bypass circuit board includes a circuit which completes the connection of the CPU with the other storage device bypass circuits and their associated storage devices whether or not the storage device is present. **Dekoning et al.** teaches that each storage device bypass circuit board includes a circuit which completes the connection of the CPU with the other storage device bypass circuits and their associated storage devices whether or not the storage device is present (Fig 6; CL11, L30-60), as that will enable detection of failure or absence of a storage device and bypassing the storage device by connecting the daisy chain loop without the device (CL11, L52-60). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Dekoning et al.** that included each storage device bypass circuit board including a circuit which completed the connection of the CPU with the other storage device bypass circuits and their associated storage devices whether or not the storage device was present. The artisan would have been motivated because that would enable detection of failure or absence of a storage device and bypassing the storage device by connecting the daisy chain loop without the device.

8.3 As per Claim 3, **Leshem, Espy, Hillis, Dekoning et al.** and **Swanson et al.** teach the system of claim 1. **Leshem** does not expressly teach each mass storage module

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including a module bypass circuit board. **Espy** teaches each mass storage module including a module bypass circuit board (Page 2, L5-23; Fig. 1, Item 40; Page 6, L7-16), as that will enable to add an additional disk array chassis to the existing system when additional memory space is required, without shutting down the existing system (Page 1, L19-24). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module including a module bypass circuit board. The artisan would have been motivated because that would enable to add an additional disk array chassis to the existing system when additional memory space was required, without shutting down the existing system.

Leshem does not expressly teach that each module bypass circuit board outputs electrical signals from the corresponding mass storage module via the optical input/output connector when light signals are received by the optical input/output connector. **Swanson et al.** teaches that each module bypass circuit board outputs electrical signals from the corresponding mass storage module via the optical input/output connector when light signals are received by the optical input/output connector (Fig. 2; CL1, L19-42), as optical transmission provides large capacity for digital transmission in computer/communication networks (CL1, L26-29). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Swanson et al.** that included each module bypass circuit board outputting electrical signals from the corresponding mass storage module via the optical input/output connector when light signals were received by the optical input/output connector. The artisan would have been motivated because

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optical transmission would provide large capacity for digital transmission in computer/communication networks.

8.4 As per Claim 5, **Leshem, Espy, Hillis, Dekoning et al.** and **Swanson et al.** teach the system of claim 1. **Leshem** does not expressly teach each of the first mass storage module and the second mass storage module including a module bypass circuit board. **Espy** teaches each of the first mass storage module and the second mass storage module including a module bypass circuit board (Page 2, L5-23; Fig. 1, Item 40; Page 6, L7-16), as that will enable to add an additional disk array chassis to the existing system when additional memory space is required, without shutting down the existing system (Page 1, L19-24). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each of the first mass storage module and the second mass storage module including a module bypass circuit board. The artisan would have been motivated because that would enable to add an additional disk array chassis to the existing system when additional memory space was required, without shutting down the existing system.

Leshem does not expressly teach that the module bypass circuit board of the first mass storage module outputs electrical signals from the first mass storage module to the second mass storage module via the optical input/output connector when light signals are received from the second mass storage module by the optical input/output connector.

Swanson et al. teaches that the module bypass circuit board of the first mass storage module outputs electrical signals from the first mass storage module to the second mass storage module via the optical input/output connector when light signals are received

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from the second mass storage module by the optical input/output connector (Fig. 2; CL1, L19-42), as optical transmission provides large capacity for digital transmission in computer/communication networks (CL1, L26-29). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Swanson et al.** that included the module bypass circuit board of the first mass storage module outputting electrical signals from the first mass storage module to the second mass storage module via the optical input/output connector when light signals are received from the second mass storage module by the optical input/output connector. The artisan would have been motivated because optical transmission would provide large capacity for digital transmission in computer/communication networks.

8.5 As per Claim 7, **Leshem, Espy, Hillis, Dekoning et al.** and **Swanson et al.** teach the system of claim 1. **Leshem** does not expressly teach that the storage devices (of each mass storage module) are disk drives. **Espy** teaches that the storage devices (of each mass storage module) are disk drives (Fig. 1, Items 12 of Items 10 and 110; Page 5, L16-17), because as per **Hillis** the storage capacity of the mass storage module will be increased proportional to the number of plug-in disks for storing information (CL11, L29-33). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included the storage devices (of each mass storage module) being disk drives. The artisan would have been motivated because the storage capacity of the mass storage

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module would be increased proportional to the number of plug-in disks for storing information.

Leshem does not expressly teach that the storage device bypass circuit boards are disk drive bypass circuit boards each having a connector to receive a disk drive. **Espy** teaches that the storage device bypass circuit boards are disk drive bypass circuit boards each having a connector to receive a disk drive (Fig. 1, Item 26 of Items 10 and 110; Page 5, L26-27; Page 5, L30 to Page 6, L2), because as per **Dekoning et al.** that will enable connecting the disk drive to the daisy-chain communication loop, when the disk drive is enabled; and when failure or absence of a disk drive is detected bypassing the disk drive by connecting the daisy chain loop without the disk drive (CL11, L52-60). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included the storage device bypass circuit boards being disk drive bypass circuit boards each having a connector to receive a disk drive. The artisan would have been motivated because that would enable connecting the disk drive to the daisy-chain communication loop, when the disk drive is enabled; and when failure or absence of a disk drive is detected bypassing the disk drive by connecting the daisy chain loop without the disk drive.

Per claim 10: **Leshem** teaches that the controller operates with a Fibre Channel protocol and the controller is Fibre Channel controller (CL2, L30-35; CL3, L33-36; CL3, L40-50).

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8.6 As per Claim 11, **Leshem, Espy, Hillis, Dekoning et al.** and **Swanson et al.** teach the system of claim 1. **Leshem** does not expressly teach that the controller is an arbitrated dual channel Fibre Channel controller. **Dekoning et al.** teaches that the controller is an arbitrated dual channel Fibre Channel controller (CL1, L57-64; CL3, L56-64), as the dual channels provide redundant loops to enhance the reliability of the storage system; so if one loop becomes inoperable, the second loop may remain operational and the information can be diverted to the other loop to enable continued communication with all devices on the redundant loop (CL3, L56-64). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Dekoning et al.** that included the controller being an arbitrated dual channel Fibre Channel controller. The artisan would have been motivated because the dual channels would provide redundant loops to enhance the reliability of the storage system; so if one loop became inoperable, the second loop might remain operational and the information could be diverted to the other loop to enable continued communication with all devices on the redundant loop.

8.7 As per Claim 12, **Leshem, Espy, Hillis, Dekoning et al.** and **Swanson et al.** teach the system of claim 10. **Leshem** does not expressly teach that each storage device (of each mass storage module) is a disk drive. **Espy** teaches that each storage device (of each mass storage module) is a disk drive (Fig. 1, Items 12 of Items 10 and 110; Page 5, L16-17), because as per **Hillis** the storage capacity of the mass storage module will be increased proportional to the number of plug-in disks for storing information (CL11, L29-33). It would have been obvious to one of ordinary skill in the art at the time of

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Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each storage device (of each mass storage module) being a disk drive. The artisan would have been motivated because the storage capacity of the mass storage module would be increased proportional to the number of plug-in disks for storing information.

Leshem does not expressly teach that each storage device bypass circuit board comprises a disk drive bypass circuit board. **Espy** teaches that each storage device bypass circuit board comprises a disk drive bypass circuit board (Fig. 1, Item 26 of Items 10 and 110; Page 5, L26-27; Page 5, L30 to Page 6, L2), because as per **Dekoning et al.** that will enable connecting the disk drive to the daisy-chain communication loop, when the disk drive is enabled; and when failure or absence of a disk drive is detected bypassing the disk drive by connecting the daisy chain loop without the disk drive (CL11, L52-60). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each storage device bypass circuit board comprising a disk drive bypass circuit board. The artisan would have been motivated because that would enable connecting the disk drive to the daisy-chain communication loop, when the disk drive is enabled; and when failure or absence of a disk drive is detected bypassing the disk drive by connecting the daisy chain loop without the disk drive.

Leshem does not expressly teach the disk drive bypass circuit board including a circuit which completes the connection of the CPU with the other drive bypass circuits and their associated disk drives whether or not the disk drive is present. **Dekoning et al.** teaches the disk drive bypass circuit board including a circuit which completes the

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connection of the CPU with the other drive bypass circuits and their associated disk drives whether or not the disk drive is present (Fig 6; CL11, L30-60), as that will enable detection of failure or absence of a storage device and bypassing the storage device by connecting the daisy chain loop without the device (CL11, L40-60). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Dekoning et al.** that included the disk drive bypass circuit board including a circuit which completes the connection of the CPU with the other drive bypass circuits and their associated disk drives whether or not the disk drive is present. The artisan would have been motivated because that would enable detection of failure or absence of a storage device and bypassing the storage device by connecting the daisy chain loop without the device.

8.8 As per Claim 13, **Leshem, Espy, Hillis, Dekoning et al.** and **Swanson et al.** teach the system of claim 12. **Leshem** does not expressly teach each mass storage module including a module bypass circuit board. **Espy** teaches each mass storage module including a module bypass circuit board (Page 2, L5-23; Fig. 1, Item 40; Page 6, L7-16), as that will enable to add an additional disk array chassis to the existing system when additional memory space is required, without shutting down the existing system (Page 1, L19-24). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module including a module bypass circuit board. The artisan would have been motivated because that would enable to add an additional disk

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array chassis to the existing system when additional memory space was required, without shutting down the existing system.

Leshem does not expressly teach that the module bypass circuit board outputs electrical signals from each mass storage module via the optical input/output connector when light signals are received by the optical input/output connector. **Swanson et al.** teaches that the module bypass circuit board outputs electrical signals from each mass storage module via the optical input/output connector when light signals are received by the optical input/output connector (Fig. 2; CL1, L19-42), as optical transmission provides large capacity for digital transmission in computer/communication networks (CL1, L26-29). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Swanson et al.** that included the module bypass circuit board outputting electrical signals from each mass storage module via the optical input/output connector when light signals were received by the optical input/output connector. The artisan would have been motivated because optical transmission would provide large capacity for digital transmission in computer/communication networks.

9. Claims 6, 16, 19-21, 23, 24, 28-31 and 34 are rejected under 35 U.S.C. 103(a) as being unpatentable over **Leshem** (U.S. Patent 5,729,763) in view of **Espy** (International Application WO 98/21660), and further in view of **Hillis** (U.S. Patent 5,978,570), **Dekoning et al.** (U.S. Patent 6,055,228), **Swanson et al.** (U.S. Patent 6,580,531) and **Harvey** (U.S. Patent 5,831,525).

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9.1 As per Claim 6, **Leshem, Espy, Hillis, Dekoning et al.** and **Swanson et al.** teach the system of claim 1. **Leshem** does not expressly teach that each mass storage module includes a storage device bypass board connector for each of the storage device bypass circuit boards. **Espy** teaches that each mass storage module includes a storage device bypass board connector for each of the storage device bypass circuit boards (Fig. 1, Item 26 of Items 10 and 110; Page 5, L26-27; Page 5, L30 to Page 6, L2), because as per **Dekoning et al.** that will enable connecting the storage device to the daisy-chain communication loop, when the device is enabled; and when failure or absence of a storage device is detected bypassing the storage device by connecting the daisy chain loop without the device (CL11, L52-60). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module including a storage device bypass board connector for each of the storage device bypass circuit boards. The artisan would have been motivated because that would enable connecting the storage device to the daisy-chain communication loop, when the device was enabled; and when failure or absence of a storage device was detected bypassing the storage device by connecting the daisy chain loop without the device.

Leshem does not expressly teach that each mass storage module includes a storage device bypass board connector for each of the storage device bypass circuit boards with an opening between each connector to permit the flow of air between the connectors and alongside the bypass circuit boards and storage devices for cooling purposes. **Harvey** teaches that each mass storage module includes a storage device bypass board connector for each of the storage device bypass circuit boards with an

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opening between each connector to permit the flow of air between the connectors and alongside the bypass circuit boards and storage devices for cooling purposes (CL5, L14-50; Fig 1; Fig 2), as that will prevent overheating of the drive and the drive related computer hardware and loss of valuable data (CL2, L1-6). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Harvey** that included each mass storage module including a storage device bypass board connector for each of the storage device bypass circuit boards with an opening between each connector to permit the flow of air between the connectors and alongside the bypass circuit boards and storage devices for cooling purposes. The artisan would have been motivated because that would prevent overheating of the drive and the drive related computer hardware and loss of valuable data.

9.2 As per Claim 16, **Leshem, Espy, Hillis, Dekoning et al.** and **Swanson et al.** teach the system of claim 11. **Leshem** does not expressly teach that the storage devices (of each mass storage module) are disk drives. **Espy** teaches that the storage devices (of each mass storage module) are disk drives (Fig. 1, Items 12 of Items 10 and 110; Page 5, L16-17), because as per **Hillis** the storage capacity of the mass storage module will be increased proportional to the number of plug-in disks for storing information (CL11, L29-33). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included the storage devices (of each mass storage module) being disk drives. The artisan would have been motivated because the storage capacity of the mass storage

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module would be increased proportional to the number of plug-in disks for storing information.

Leshem does not expressly teach that the storage device bypass circuit boards are disk drive bypass circuit boards. **Espy** teaches that the storage device bypass circuit boards are disk drive bypass circuit boards (Fig. 1, Item 26 of Items 10 and 110; Page 5, L26-27; Page 5, L30 to Page 6, L2), because as per **Dekoning et al.** that will enable connecting the disk drive to the daisy-chain communication loop, when the disk drive is enabled; and when failure or absence of a disk drive is detected bypassing the disk drive by connecting the daisy chain loop without the disk drive (CL11, L52-60). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included the storage device bypass circuit boards being disk drive bypass circuit boards. The artisan would have been motivated because that would enable connecting the disk drive to the daisy-chain communication loop, when the disk drive is enabled; and when failure or absence of a disk drive is detected bypassing the disk drive by connecting the daisy chain loop without the disk drive.

Leshem does not expressly teach that the at least one module includes a disk drive bypass board connector for each of the disk drive bypass circuit boards with an opening between each connector to permit the flow of air between the connectors and alongside the bypass circuit boards and disk drives for cooling purposes. **Harvey** teaches that the at least one module includes a disk drive bypass board connector for each of the disk drive bypass circuit boards with an opening between each connector to permit the flow of air between the connectors and alongside the bypass circuit boards and disk

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drives for cooling purposes (CL5, L14-50; Fig 1; Fig 2), as that will prevent overheating of the drive and the drive related computer hardware and loss of valuable data (CL2, L1-6). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Harvey** that included the at least one module including a disk drive bypass board connector for each of the disk drive bypass circuit boards with an opening between each connector to permit the flow of air between the connectors and alongside the bypass circuit boards and disk drives for cooling purposes. The artisan would have been motivated because that would prevent overheating of the drive and the drive related computer hardware and loss of valuable data.

9.3 As per Claim 19, **Leshem** teaches a high speed mass storage system (CL1, L4-8; CL1, L33-37; Abstract, L11-14); comprising at least one module containing:

at least one CPU (Fig 1, Item 22; CL3, L26-27).

Leshem does not expressly teach a high speed mass storage system which is readily expandable to increase its storage capacity while the system is in operation; and first and second mass storage modules. **Espy** teaches a high speed mass storage system which is readily expandable to increase its storage capacity while the system is in operation (Page 1, L19-24); and first and second mass storage modules (Fig. 1, Items 10 and 110; Page 1, L19-24), as that will enable to add an additional disk array chassis to the existing system when additional memory space is required, without shutting down the existing system (Page 1, L19-24). It would have been obvious to one of ordinary skill in

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the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included high speed mass storage system which would be readily expandable to increase its storage capacity while the system was in operation; and first and second mass storage modules. The artisan would have been motivated because that would enable to add an additional disk array chassis to the existing system when additional memory space was required, without shutting down the existing system.

Leshem does not expressly teach each mass storage module including a plurality of plug-in storage devices for storing information. **Espy** teaches each mass storage module including a plurality of plug-in storage devices for storing information (Fig. 1, Items 12 of Items 10 and 110; Page 5, L16-17), because as per **Hillis** the storage capacity of the mass storage module will be increased proportional to the number of plug-in storage devices for storing information (CL11, L29-33). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module including a plurality of plug-in storage devices for storing information. The artisan would have been motivated because the storage capacity of the mass storage module would be increased proportional to the number of plug-in storage devices for storing information.

Leshem does not expressly teach each mass storage module including a disk drive bypass circuit board associated with each disk drive. **Espy** teaches each mass storage module including a disk drive bypass circuit board associated with each disk drive (Fig. 1, Item 26 of Items 10 and 110; Page 5, L26-27; Page 5, L30 to Page 6, L2), because as per **Dekoning et al.** that will enable connecting the storage device to the daisy-chain communication loop, when the device is enabled; and when failure or absence of a

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storage device is detected bypassing the storage device by connecting the daisy chain loop without the device (CL11, L52-60). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module including a disk drive bypass circuit board associated with each disk drive. The artisan would have been motivated because that would enable connecting the storage device to the daisy-chain communication loop, when the device was enabled; and when failure or absence of a storage device was detected bypassing the storage device by connecting the daisy chain loop without the device.

Leshem does not expressly teach a disk drive bypass circuit board associated with each disk drive and including a disk drive connector at one edge thereof and a bypass board connector at another edge thereof, each disk drive being plugged into the disk drive connector on the disk drive bypass circuit board. **Harvey** teaches a disk drive bypass circuit board associated with each disk drive and including a disk drive connector at one edge thereof and a bypass board connector at another edge thereof, each disk drive being plugged into the disk drive connector on the disk drive bypass circuit board (CL5, L14-50; Fig 2, Items 226, 228 and 230), as that will connect the computer's electronic circuitry necessary for operating the data storage device to the circuit board through the multipin connector and through the connector at the other end to the data storage device (CL5, L14-28). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Harvey** that included a disk drive bypass circuit board associated with each disk drive and including a disk drive connector at one edge thereof and a bypass board connector at another edge

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thereof, each disk drive being plugged into the disk drive connector on the disk drive bypass circuit board. The artisan would have been motivated because that would connect the computer's electronic circuitry necessary for operating the data storage device to the circuit board through the multipin connector and through the connector at the other end to the data storage device.

Leshem does not expressly teach that the optical input/output connectors of the first and second mass storage modules are connected by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light. **Espy** teaches that the optical input/output connectors of the first and second mass storage modules are connected by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light (Page 2, L29 to Page 3, L6; Page 6, L7-16), because as per **Leshem** the fiber optic transmission will provide high data rates (CL1, L31-35). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included the optical input/output connectors of the first and second mass storage modules being connected by a fiber optic transmission medium such that signals were communicated between the first and second mass storage modules in the form of light. The artisan would have been motivated because the fiber optic transmission would provide high data rates.

In addition, **Hillis** teaches that the optical input/output connectors of the first and second mass storage modules are connected by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light (Fig. 5; Fig. 6; CL10, L59 to CL11, L5; CL11, L29-33; CL11, L34-51),

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because fiber optic communication lines have high band width and data rates of 100 megabits per second (CL11, L43-48). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Hillis** that included the optical input/output connectors of the first and second mass storage modules being connected by a fiber optic transmission medium such that signals were communicated between the first and second mass storage modules in the form of light. The artisan would have been motivated because fiber optic communication lines would have high band width and data rates of 100 megabits per second.

Leshem does not expressly teach each mass storage module including a module bypass circuit board. **Espy** teaches each mass storage module including a module bypass circuit board (Page 2, L5-23; Fig. 1, Item 40; Page 6, L7-16), as that will enable to add an additional disk array chassis to the existing system when additional memory space is required, without shutting down the existing system (Page 1, L19-24). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module including a module bypass circuit board. The artisan would have been motivated because that would enable to add an additional disk array chassis to the existing system when additional memory space was required, without shutting down the existing system.

Leshem does not expressly teach the module bypass circuit board including an optical input/ output connector for outputting electrical signals from the module as light signals and for inputting light signals into the module as electrical signals. **Swanson et al.** teaches the module bypass circuit board including an optical input/ output connector

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for outputting electrical signals from the module as light signals and for inputting light signals into the module as electrical signals (Fig. 2; CL1, L19-42), as optical transmission provides large capacity for digital transmission in computer/communication networks (CL1, L26-29). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Swanson et al.** that included the module bypass circuit board including an optical input/ output connector for outputting electrical signals from the module as light signals and for inputting light signals into the module as electrical signals. The artisan would have been motivated because optical transmission would provide large capacity for digital transmission in computer/communication networks.

Leshem teaches a controller connecting the CPU with some of the disk drives through its associated drive bypass circuit board (CL3, L33-36; CL3, L40-50). **Leshem** does not expressly teach a controller connecting the CPU with each of the disk drives through its associated drive bypass circuit board. **Espy** teaches a controller connecting the CPU with each of the disk drives through its associated drive bypass circuit board (Fig. 1, Item 16; Items 12, 22 and 26), because as per **Dekoning et al.** that will enable connecting the storage device to the daisy-chain communication loop, when the device is enabled; and when failure or absence of a storage device is detected bypassing the storage device by connecting the daisy chain loop without the device (CL11, L52-60). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included a controller connecting the CPU with each of the disk drives through its associated drive bypass circuit board. The artisan would have been motivated because that would enable

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connecting the storage device to the daisy-chain communication loop, when the device was enabled; and when failure or absence of a storage device was detected bypassing the storage device by connecting the daisy chain loop without the device.

Leshem does not expressly teach a controller connecting the CPU with each of the disk drives through its associated drive bypass circuit board and through the module bypass circuit board such that a loop is formed between the output and input of the controller with each disk drive bypass circuit board and the module bypass circuit board in said loop. **Espy** teaches a controller connecting the CPU with each of the disk drives through its associated drive bypass circuit board and through the module bypass circuit board such that a loop is formed between the output and input of the controller with each disk drive bypass circuit board and the module bypass circuit board in said loop (Page 2, L5-23; Fig 1, Item 40; Page 6, L7-16), as that will enable to add an additional disk array chassis to the existing system when additional memory space is required, without shutting down the existing system (Page 1, L19-24). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included a controller connecting the CPU with each of the disk drives through its associated drive bypass circuit board and through the module bypass circuit board such that a loop was formed between the output and input of the controller with each disk drive bypass circuit board and the module bypass circuit board in said loop. The artisan would have been motivated because that would enable to add an additional disk array chassis to the existing system when additional memory space was required, without shutting down the existing system.

Leshem does not expressly teach completing the loop whether or not a disk drive is plugged into the disk drive connector. **Dekoning et al.** teaches completing the loop whether or not a disk drive is plugged into the disk drive connector (Fig 6; CL11, L30-60), as that will enable detection of failure or absence of a storage device and bypassing the storage device by connecting the daisy chain loop without the device (CL11, L40-60). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Dekoning et al.** that included completing the loop whether or not a disk drive is plugged into the disk drive connector. The artisan would have been motivated because that would enable detection of failure or absence of a storage device and bypassing the storage device by connecting the daisy chain loop without the device.

9.4 As per Claim 20, **Leshem, Espy, Hillis, Dekoning et al, Swanson et al.** and **Harvey** teach the system of claim 19. **Leshem** does not expressly teach that the module bypass circuit board of the first mass storage module completes the loop through the second module. **Espy** teaches that the module bypass circuit board of the first mass storage module completes the loop through the second module (Fig. 1, Items 40, 50, 52 of Item 110 and Item 10), as that will enable to add an additional disk array chassis to the existing system when additional memory space is required, without shutting down the existing system (Page 1, L19-24). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included the module bypass circuit board of the first mass storage module completing the loop through the second module. The artisan would have been

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motivated because that would enable to add an additional disk array chassis to the existing system when additional memory space is required, without shutting down the existing system.

9.5 As per Claim 21, **Leshem, Espy, Hillis, Dekoning et al, Swanson et al. and Harvey** teach the system of claim 19. **Leshem** does not expressly teach each mass storage module including a module bypass circuit board. **Espy** teaches each mass storage module including a module bypass circuit board (Page 2, L5-23; Fig. 1, Item 40; Page 6, L7-16), as that will enable to add an additional disk array chassis to the existing system when additional memory space is required, without shutting down the existing system (Page 1, L19-24). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module including a module bypass circuit board. The artisan would have been motivated because that would enable to add an additional disk array chassis to the existing system when additional memory space was required, without shutting down the existing system.

Leshem does not expressly teach that the module bypass circuit board outputs electrical signals from each mass storage module via the optical input/output connector when light signals are received by the optical input/output connector. **Swanson et al.** teaches that the module bypass circuit board outputs electrical signals from each mass storage module via the optical input/output connector when light signals are received by the optical input/output connector (Fig. 2; CL1, L19-42), as optical transmission provides large capacity for digital transmission in computer/communication networks (CL1, L26-

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29). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Swanson et al.** that included the module bypass circuit board outputting electrical signals from each mass storage module via the optical input/output connector when light signals were received by the optical input/output connector. The artisan would have been motivated because optical transmission would provide large capacity for digital transmission in computer/communication networks.

9.6 As per Claim 23, **Leshem, Espy, Hillis, Dekoning et al, Swanson et al.** and **Harvey** teach the system of claim 19. **Leshem** does not expressly teach each of the first mass storage module and the second mass storage module including a module bypass circuit board. **Espy** teaches each of the first mass storage module and the second mass storage module including a module bypass circuit board (Page 2, L5-23; Fig. 1, Item 40; Page 6, L7-16), as that will enable to add an additional disk array chassis to the existing system when additional memory space is required, without shutting down the existing system (Page 1, L19-24). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each of the first mass storage module and the second mass storage module including a module bypass circuit board. The artisan would have been motivated because that would enable to add an additional disk array chassis to the existing system when additional memory space was required, without shutting down the existing system.

Leshem does not expressly teach that the module bypass circuit board of each mass storage module outputs electrical signals from the first mass storage module to the

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second mass storage module via the optical input/output connector when light signals are received from the second mass storage module by the optical input/output connector.

Swanson et al. teaches that the module bypass circuit board of each mass storage module outputs electrical signals from the first mass storage module to the second mass storage module via the optical input/output connector when light signals are received from the second mass storage module by the optical input/output connector (Fig. 2; CL1, L19-42), as optical transmission provides large capacity for digital transmission in computer/communication networks (CL1, L26-29). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Swanson et al.** that included the module bypass circuit board of each mass storage module outputting electrical signals from the first mass storage module to the second mass storage module via the optical input/output connector when light signals are received from the second mass storage module by the optical input/output connector. The artisan would have been motivated because optical transmission would provide large capacity for digital transmission in computer/communication networks.

9.7 As per Claim 24, **Leshem, Espy, Hillis, Dekoning et al, Swanson et al.** and **Harvey** teach the system of claim 19. **Leshem** does not expressly teach that each mass storage module includes a drive bypass board connector for each drive bypass circuit boards. **Espy** teaches that each mass storage module includes a drive bypass board connector for each drive bypass circuit boards (Fig. 1, Item 26 of Items 10 and 110; Page 5, L26-27; Page 5, L30 to Page 6, L2), because as per **Dekoning et al.** that will enable

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connecting the drive to the daisy-chain communication loop, when the drive is enabled; and when failure or absence of a drive is detected bypassing the drive by connecting the daisy chain loop without the drive (CL11, L52-60). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module including a drive bypass board connector for each drive bypass circuit boards. The artisan would have been motivated because that would enable connecting the drive to the daisy-chain communication loop, when the drive was enabled; and when failure or absence of a drive was detected bypassing the drive by connecting the daisy chain loop without the drive.

Leshem does not expressly teach that each mass storage module includes a drive bypass board connector for each of the drive bypass circuit boards with an opening between each connector to permit the flow of air between the connectors and alongside the bypass circuit boards and disk drives for cooling purposes. **Harvey** teaches that each mass storage module includes a drive bypass board connector for each of the drive bypass circuit boards with an opening between each connector to permit the flow of air between the connectors and alongside the bypass circuit boards and disk drives for cooling purposes (CL5, L14-50; Fig 1; Fig 2), as that will prevent overheating of the drive and the drive related computer hardware and loss of valuable data (CL2, L1-6). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Harvey** that included each mass storage module including a drive bypass board connector for each of the drive bypass circuit boards with an opening between each connector to permit the flow of air between the connectors and alongside the bypass circuit boards and disk drives for cooling

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purposes. The artisan would have been motivated because that would prevent overheating of the drive and the drive related computer hardware and loss of valuable data.

Per claim 28: **Leshem** teaches that the controller operates with a Fiber Channel protocol and the controller is Fiber Channel controller (CL2, L30-35; CL3, L33-36; CL3, L40-50).

9.8 As per Claim 29, **Leshem, Espy, Hillis, Dekoning et al, Swanson et al.** and **Harvey** teach the system of claim 19. **Leshem** does not expressly teach that the controller is an arbitrated dual channel Fiber Channel controller. **Dekoning et al.** teaches that the controller is an arbitrated dual channel Fiber Channel controller (CL1, L57-64; CL3, L56-64), as the dual channels provide redundant loops to enhance the reliability of the storage system; so if one loop becomes inoperable, the second loop may remain operational and the information can be diverted to the other loop to enable continued communication with all devices on the redundant loop (CL3, L56-64). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Dekoning et al.** that included the controller being an arbitrated dual channel Fiber Channel controller. The artisan would have been motivated because the dual channels would provide redundant loops to enhance the reliability of the storage system; so if one loop became inoperable, the second loop might remain operational and the information could be diverted to the other loop to enable continued communication with all devices on the redundant loop.

9.9 As per Claim 30, **Leshem, Espy, Hillis, Dekoning et al, Swanson et al. and Harvey** teach the system of claim 29. **Leshem** does not expressly teach that each drive bypass circuit board includes a circuit which completes the connection of the CPU with the other storage device bypass circuits and their associated storage devices whether or not the storage device is present. **Dekoning et al.** teaches that each drive bypass circuit board includes a circuit which completes the connection of the CPU with the other storage device bypass circuits and their associated storage devices whether or not the storage device is present (Fig 6; CL11, L30-60), as that will enable detection of failure or absence of a storage device and bypassing the storage device by connecting the daisy chain loop without the device (CL11, L52-60). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Dekoning et al.** that included each drive bypass circuit board including a circuit which completed the connection of the CPU with the other storage device bypass circuits and their associated storage devices whether or not the storage device was present. The artisan would have been motivated because that would enable detection of failure or absence of a storage device and bypassing the storage device by connecting the daisy chain loop without the device.

9.10 As per Claim 31, it is a system claim having the same limitations as Claim 21. Therefore, Claim 31 is rejected based on the same reasoning as Claim 21, supra.

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9.11 As per Claim 34, it is a system claim having the same limitations as Claim 24.

Therefore, Claim 34 is rejected based on the same reasoning as Claim 24, supra.

10. Claims 8, 9, 17, 18, 25-27, 35 and 36 are rejected under 35 U.S.C. 103(a) as being unpatentable over **Leshem** (U.S. Patent 5,729,763) in view of **Espy** (International Application WO 98/21660), and further in view of **Hillis** (U.S. Patent 5,978,570), **Dekoning et al.** (U.S. Patent 6,055,228), **Swanson et al.** (U.S. Patent 6,580,531), **Harvey** (U.S. Patent 5,831,525) and **Kimura et al.** (U.S. Patent 5,414,591).

10.1 As per Claim 8, **Leshem**, **Espy**, **Hillis**, **Dekoning et al.** and **Swanson et al.** teach the system of claim 7. **Leshem** does not expressly teach that each mass storage module includes a disk drive bypass circuit board connector for each of the drive bypass circuit boards. **Espy** teaches that each mass storage module includes a disk drive bypass circuit board connector for each of the drive bypass circuit boards (Fig. 1, Item 26 of Items 10 and 110; Page 5, L26-27; Page 5, L30 to Page 6, L2), because as per **Dekoning et al.** that will enable connecting the disk drive to the daisy-chain communication loop, when the disk drive is enabled; and when failure or absence of a disk drive is detected bypassing the disk drive by connecting the daisy chain loop without the disk drive (CL11, L52-60). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module including a disk drive bypass circuit board connector for each of the drive bypass circuit boards. The artisan would have been motivated because that would enable connecting the disk drive to the daisy-chain communication loop, when the disk

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drive was enabled; and when failure or absence of a disk drive was detected bypassing the disk drive by connecting the daisy chain loop without the disk drive.

Leshem does not expressly teach that each mass storage module includes a disk drive bypass circuit board connector for each of the drive bypass circuit boards with an opening between each connector to permit the flow of air between the connectors.

Harvey teaches that each mass storage module includes a disk drive bypass circuit board connector for each of the drive bypass circuit boards with an opening between each connector to permit the flow of air between the connectors (CL5, L14-50; Fig 1; Fig 2), as that will prevent overheating of the drive and the drive related computer hardware and loss of valuable data (CL2, L1-6). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Harvey** that included each mass storage module including a disk drive bypass circuit board connector for each of the drive bypass circuit boards with an opening between each connector to permit the flow of air between the connectors. The artisan would have been motivated because that would prevent overheating of the drive and the drive related computer hardware and loss of valuable data.

Leshem does not expressly teach that each drive bypass circuit board is a relatively flat circuit board with a connector on opposite edges, wherein one of the connectors is the connector which receives the disk drive and the other connector connects to the drive bypass circuit board connector. **Harvey** teaches that each drive bypass circuit board is a circuit board with a connector on opposite edges, wherein one of the connectors is the connector which receives the disk drive and the other connector connects to the drive bypass circuit board connector (CL5, L14-50; Fig 2, Items 226, 228

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and 230), as that will connect the computer's electronic circuitry necessary for operating the data storage device to the circuit board through the multipin connector and through the connector at the other end to the data storage device (CL5, L14-28). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Harvey** that included each drive bypass circuit board being a circuit board with a connector on opposite edges, wherein one of the connectors was the connector which received the disk drive and the other connector connected to the drive bypass circuit board connector. The artisan would have been motivated because that would connect the computer's electronic circuitry necessary for operating the data storage device to the circuit board through the multipin connector and through the connector at the other end to the data storage device.

Leshem does not expressly teach that each drive bypass circuit board is a relatively flat circuit board. **Kimura et al.** teaches that each drive bypass circuit board is a relatively flat circuit board (Fig 19; Fig 20; CL11, L19-52), as that will allow the cooling air that has cooled the disk drive to flow over the circuit board, the board being along the cooling air flow (CL11, L34-38). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Kimura et al.** that included each drive bypass circuit board being a relatively flat circuit board. The artisan would have been motivated because that would allow the cooling air that has cooled the disk drive to flow over the circuit board, the board being along the cooling air flow.

Leshem does not expressly teach the connectors, bypass circuit boards and drives being arranged such that when they are connected there is a path for air flow from outside

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the module alongside each bypass circuit board and its associated disk drive for cooling purposes without any backplane obstruction. **Harvey** teaches the connectors, bypass circuit boards and drives being arranged such that when they are connected there is a path for air flow from outside the module alongside each bypass circuit board and its associated disk drive for cooling purposes without any backplane obstruction (CL5, L14-20; Fig 1; Fig 2), as that will improve the hard drive and circuit board cooling and prevent overheating of the drive and the drive related computer hardware and loss of valuable data (CL1, L60-62; CL2, L1-6). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Harvey** that included the connectors, bypass circuit boards and drives being arranged such that when they were connected there was a path for air flow from outside the module alongside each bypass circuit board and its associated disk drive for cooling purposes without any backplane obstruction. The artisan would have been motivated because that would improve the hard drive and circuit board cooling and prevent overheating of the drive and the drive related computer hardware and loss of valuable data.

10.2 As per Claim 9, **Leshem, Espy, Hillis, Dekoning et al., Swanson et al., Harvey** and **Kimura et al.** teach the system of claim 8. **Leshem** does not expressly teach that each mass storage module is housed in an enclosure and at least one fan is mounted to force air from outside the enclosure through the spaces between the bypass boards and drives. **Espy** teaches that each mass storage module is housed in an enclosure and at least one fan is mounted to force air from outside the enclosure through the spaces

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between the bypass boards and drives (Page 5, L16-19), as the disk array chassis provides a series of openings into which several disk drives may be inserted (Page 5, L15-17); and as per **Harvey**, the fan provides air flow through the drive module and around the circuit board (CL5, L35-50). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module being housed in an enclosure and at least one fan being mounted to force air from outside the enclosure through the spaces between the bypass boards and drives. The artisan would have been motivated because the disk array chassis would provide a series of openings into which several disk drives could be inserted and the fan would provide air flow through the drive module and around the circuit board.

10.3 As per Claims 17-18, these are system claims having the same limitations as Claims 8-9. Therefore, Claims 17-18 are rejected based on the same reasoning as Claims 8-9, supra.

10.4 As per Claim 25, **Leshem, Espy, Hillis, Dekoning et al, Swanson et al.** and **Harvey** teach the system of claim 19. **Leshem** does not expressly teach that each mass storage module includes a drive bypass board connector for each drive bypass circuit boards. **Espy** teaches that each mass storage module includes a drive bypass board connector for each drive bypass circuit boards (Fig. 1, Item 26 of Items 10 and 110; Page 5, L26-27; Page 5, L30 to Page 6, L2), because as per **Dekoning et al.** that will enable connecting the drive to the daisy-chain communication loop, when the drive is enabled;

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and when failure or absence of a drive is detected bypassing the drive by connecting the daisy chain loop without the drive (CL11, L52-60). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Espy** that included each mass storage module including a drive bypass board connector for each drive bypass circuit boards. The artisan would have been motivated because that would enable connecting the drive to the daisy-chain communication loop, when the drive was enabled; and when failure or absence of a drive was detected bypassing the drive by connecting the daisy chain loop without the drive.

Leshem does not expressly teach that each drive bypass circuit board is a relatively flat circuit board with a connector on opposite edges, wherein one of the connectors is the connector which receives the disk drive and the other connector connects to the drive bypass circuit board connector. **Harvey** teaches that each drive bypass circuit board is a circuit board with a connector on opposite edges, wherein one of the connectors is the connector which receives the disk drive and the other connector connects to the drive bypass circuit board connector (CL5, L14-50; Fig 2, Items 226, 228 and 230), as that will connect the computer's electronic circuitry necessary for operating the data storage device to the circuit board through the multipin connector and through the connector at the other end to the data storage device (CL5, L14-28). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Harvey** that included each drive bypass circuit board being a circuit board with a connector on opposite edges, wherein one of the connectors was the connector which received the disk drive and the other connector connected to the drive bypass circuit board connector. The artisan would have been

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motivated because that would connect the computer's electronic circuitry necessary for operating the data storage device to the circuit board through the multipin connector and through the connector at the other end to the data storage device.

Leshem does not expressly teach that each drive bypass circuit board is a relatively flat circuit board. **Kimura et al.** teaches that each drive bypass circuit board is a relatively flat circuit board (Fig 19; Fig 20; CL11, L19-52), as that will allow the cooling air that has cooled the disk drive to flow over the circuit board, the board being along the cooling air flow (CL11, L34-38). It would have been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Kimura et al.** that included each drive bypass circuit board being a relatively flat circuit board. The artisan would have been motivated because that would allow the cooling air that has cooled the disk drive to flow over the circuit board, the board being along the cooling air flow.

Leshem does not expressly teach the connectors, bypass circuit boards and drives being arranged such that when they are connected there is a path for air flow from outside each mass storage module alongside each bypass circuit board and its associated disk drive for cooling purposes without any backplane obstruction. **Harvey** teaches the connectors, bypass circuit boards and drives being arranged such that when they are connected there is a path for air flow from outside each mass storage module alongside each bypass circuit board and its associated disk drive for cooling purposes without any backplane obstruction (CL5, L14-20; Fig 1; Fig 2), as that will improve the hard drive and circuit board cooling and prevent overheating of the drive and the drive related computer hardware and loss of valuable data (CL1, L60-62; CL2, L1-6). It would have

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been obvious to one of ordinary skill in the art at the time of Applicants' invention to modify the system of **Leshem** with the system of **Harvey** that included the connectors, bypass circuit boards and drives being arranged such that when they were connected there was a path for air flow from outside each mass storage module alongside each bypass circuit board and its associated disk drive for cooling purposes without any backplane obstruction. The artisan would have been motivated because that would improve the hard drive and circuit board cooling and prevent overheating of the drive and the drive related computer hardware and loss of valuable data.

10.5 As per Claim 26, it is a system claim having the same limitations as Claim 9. Therefore, Claim 26 is rejected based on the same reasoning as Claim 9, supra.

10.6 As per Claim 27, **Leshem** teaches that each drive bypass circuit board connector is mounted in the same plane in spaced relationship with each other (Fig 2A).

10.7 As per Claims 35-36, these are system claims having the same limitations as Claims 25-26. Therefore, Claims 35-36 are rejected based on the same reasoning as Claims 25-26, supra.

Response to Arguments

11. As per the applicants' argument that "Keaveny et al. does not teach, disclose or suggest connecting optical input/output connectors of first and second mass storage

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modules by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light; ... While Swanson et al. teaches an optical transceiver system, Swanson et al. modules by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light; ... Dekoning et al. also does not teach, disclose or suggest connecting optical input/output connectors of first and second mass storage modules by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light; ... Espy also does not teach, disclose or suggest connecting optical input/output connectors of first and second mass storage modules by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light; ... Harvey does not teach, disclose or suggest connecting optical input/output connectors of first and second mass storage modules by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light; ... Kimura et al. also does not teach, disclose or suggest connecting optical input/output connectors of first and second mass storage modules by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light”, the Examiner respectfully disagrees.

Espy teaches that the optical input/output connectors of the first and second mass storage modules are connected by a fiber optic transmission medium such that signals are

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communicated between the first and second mass storage modules in the form of light (Page 2, L29 to Page 3, L6; Page 6, L7-16).

In addition, **Hillis** teaches that the optical input/output connectors of the first and second mass storage modules are connected by a fiber optic transmission medium such that signals are communicated between the first and second mass storage modules in the form of light (Fig. 5; Fig. 6; CL10, L59 to CL11, L5; CL11, L29-33; CL11, L34-51), because fiber optic communication lines have high band width and data rates of 100 megabits per second (CL11, L43-48).

Conclusion

ACTION IS FINAL

12. Applicants' amendments necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire **THREE MONTHS** from the mailing date of this action. In the event a first reply is filed within **TWO MONTHS** of the mailing date of this final action and the advisory action is not mailed until after the end of the **THREE-MONTH** shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any

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extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

13. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Dr. Kandasamy Thangavelu whose telephone number is 571-272-3717. The examiner can normally be reached on Monday through Friday from 8:00 AM to 5:30 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Kevin Teska, can be reached on 571-272-3716. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

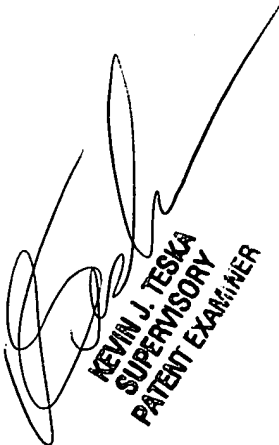
Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to TC 2100 Group receptionist: 571-272-2100.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR

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system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

K. Thangavelu
Art Unit 2123
April 16, 2005



KEVIN J. TESKA
SUPERVISORY
PATENT EXAMINER